

# 捷多邦,专业PCB打样工厂,24小时加急出货

1A

1B

1Y 3

2A

2B

2Y

GND

5

6

#### SN74LVC00A-Q1 QUADRUPLE 2-INPUT POSITIVE-NAND GATE

**D OR PW PACKAGE** 

(TOP VIEW)

14

13

10

9

8 3Y

SCAS703A-SEPTEMBER 2003-REVISED JUNE 2005

Vcc

12 4A

11 🛛 4Y

3B

🛛 за

4B

### FEATURES

- Qualification in Accordance With AEC-Q100 (1)
- Qualified for Automotive Applications
- Customer-Specific Configuration Control Can Be Supported Along With Major-Change Approval
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Operates From 2 V to 3.6 V
- Inputs Accept Voltages to 5.5 V
- Max t<sub>pd</sub> of 4.3 ns at 3.3 V
- Typical V<sub>OLP</sub> (Output Ground Bounce) < 0.8 V at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C
- Typical V<sub>OHV</sub> (Output V<sub>OH</sub> Undershoot) > 2 V at  $V_{CC} = 3.3 \text{ V}, T_A = 25^{\circ}\text{C}$
- Contact factory for details. Q100 qualification data available on request.

## **DESCRIPTION/ORDERING INFORMATION**

The SN74LVC00A-Q1 quadruple 2-input positive-NAND gate is designed for 2.7-V to 3.6-V V<sub>CC</sub> operation.

The device performs the Boolean function  $Y = \overline{A \cdot B}$  or  $Y = \overline{A} + \overline{B}$  in positive logic.

Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of this device as a translator in a mixed 3.3-V/5-V system environment.

#### ORDERING INFORMATION

| T <sub>A</sub> | PACKAGE <sup>(1)</sup> ORDERABLE PART NUMBER |              |                  | TOP-SIDE MARKING |
|----------------|--|--------------|------------------|------------------|
| 40%C to 125%C  | SOIC – D                                     | Reel of 2500 | SN74LVC00AQDRQ1  | LVC00AQ          |
| –40°C to 125°C | TSSOP – PW                                   | Reel of 2000 | SN74LVC00AQPWRQ1 | LVC00AQ          |

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

| INPUTS |  |
|--------|--|
| Α      |  |
| Н      |  |
| L      |  |
| Х      |  |

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# SN74LVC00A-Q1 **QUADRUPLE 2-INPUT POSITIVE-NAND GATE**

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## Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

|                  |  |                    | MIN                   | MAX  | UNIT |
|------------------|--|--------------------|-----------------------|------|------|
| $V_{CC}$         | Supply voltage range                       | -0.5               | 6.5                   | V    |      |
| VI               | Input voltage range <sup>(2)</sup>         |                    | -0.5                  | 6.5  | V    |
| Vo               | Output voltage range <sup>(2)(3)</sup>     | -0.5               | V <sub>CC</sub> + 0.5 | V    |      |
| I <sub>IK</sub>  | Input clamp current                        | V <sub>1</sub> < 0 |                       | -50  | mA   |
| I <sub>OK</sub>  | Output clamp current                       | V <sub>O</sub> < 0 |                       | -50  | mA   |
| I <sub>O</sub>   | Continuous output current                  |                    |                       | ±50  | mA   |
|                  | Continuous current through $V_{CC}$ or GND |                    |                       | ±100 | mA   |
|                  | Decline the recel impedance (4)            | D package          |                       | 86   | 0000 |
| $\theta_{JA}$    | Package thermal impedance <sup>(4)</sup>   | PW package         |                       | 113  | °C/W |
| T <sub>stg</sub> | Storage temperature range                  |                    | -65                   | 150  | °C   |

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STRUMENTS www.ti.com

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating" conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed. (2)

(3) (4) The value of  $V_{CC}$  is provided in the recommended operating conditions table. The package thermal impedance is calculated in accordance with JESD 51-7.

## Recommended Operating Conditions<sup>(1)</sup>

|                 |                                |                                  | MIN | MAX      | UNIT |
|-----------------|--------------------------------|----------------------------------|-----|----------|------|
| V               | Supply voltogo                 | Operating                        | 2   | 3.6      | V    |
| V <sub>CC</sub> | Supply voltage                 | Data retention only              | 1.5 |          | v    |
| VIH             | High-level input voltage       | V <sub>CC</sub> = 2.7 V to 3.6 V | 2   |          | V    |
| VIL             | Low-level input voltage        | V <sub>CC</sub> = 2.7 V to 3.6 V |     | 0.8      | V    |
| VI              | Input voltage                  |                                  | 0   | 5.5      | V    |
| Vo              | Output voltage                 |                                  | 0   | $V_{CC}$ | V    |
|                 | Lich lovel output ourroat      | $V_{CC} = 2.7 V$                 |     | -12      | mA   |
| ЮН              | High-level output current      | $V_{CC} = 3 V$                   |     | -24      | ША   |
|                 | Low-level output current       | $V_{CC} = 2.7 V$                 |     | 12       | mA   |
| IOL             |                                | $V_{CC} = 3 V$                   |     | 24       |      |
| T <sub>A</sub>  | Operating free-air temperature |                                  | -40 | 125      | °C   |

All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



# SN74LVC00A-Q1 QUADRUPLE 2-INPUT POSITIVE-NAND GATE

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### **Electrical Characteristics**

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER       | TEST CONDITIONS  | V <sub>cc</sub> | MIN                   | TYP <sup>(1)</sup> | MAX  | UNIT |
|-----------------|--|-----------------|-----------------------|--------------------|------|------|
|                 | $I_{OH} = -100 \ \mu A$  | 2.7 V to 3.6 V  | V <sub>CC</sub> – 0.2 |                    |      |      |
| N/              | 10   | 2.7 V           | 2.2                   |                    |      | V    |
| V <sub>OH</sub> | $I_{OH} = -12 \text{ mA}$                                      | 3 V             | 2.4                   |                    |      | V    |
|                 | $I_{OH} = -24 \text{ mA}$                                      | 3 V             | 2.2                   |                    |      |      |
|                 | I <sub>OL</sub> = 100 μA                                       | 2.7 V to 3.6 V  |                       |                    | 0.2  |      |
| V <sub>OL</sub> | $I_{OL} = 12 \text{ mA}$                                       | 2.7 V           |                       |                    | 0.4  | V    |
|                 | $I_{OL} = 24 \text{ mA}$                                       | 3 V             |                       |                    | 0.55 |      |
| l <sub>l</sub>  | $V_1 = 5.5 \text{ V or GND}$                                   | 3.6 V           |                       |                    | ±5   | μA   |
| I <sub>CC</sub> | $V_{I} = V_{CC} \text{ or } GND, \qquad I_{O} = 0$             | 3.6 V           |                       |                    | 10   | μA   |
| $\Delta I_{CC}$ | One input at $V_{CC}$ – 0.6 V, Other inputs at $V_{CC}$ or GND | 2.7 V to 3.6 V  |                       |                    | 500  | μA   |
| Ci              | $V_{I} = V_{CC}$ or GND  | 3.3 V           |                       | 5                  |      | pF   |

(1) All typical values are at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C.

### **Switching Characteristics**

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

| PARAMETER       | FROM<br>(INPUT) | TO<br>(OUTPUT) | $V_{CC} = 2.7 V$ |     | V <sub>CC</sub> = 3.3 V<br>± 0.3 V |     | UNIT |
|-----------------|-----------------|----------------|------------------|-----|------------------------------------|-----|------|
|                 | (INFOT)         | (001F01)       | MIN MA           | X N | /IN                                | MAX |      |
| t <sub>pd</sub> | A or B          | Y              | 5.               | 1   | 1                                  | 4.3 | ns   |

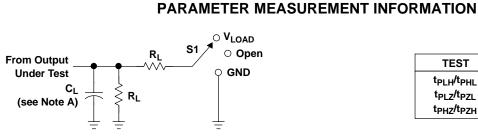
## **Operating Characteristics**

 $T_A = 25^{\circ}C$ 

|                 | PARAMETER                              | TEST<br>CONDITIONS | V <sub>CC</sub> = 2.5 V<br>TYP | V <sub>CC</sub> = 3.3 V<br>TYP | UNIT |
|-----------------|--|--------------------|--------------------------------|--------------------------------|------|
| C <sub>pd</sub> | Power dissipation capacitance per gate | f = 10 MHz         | 18                             | 19                             | pF   |

# SN74LVC00A-Q1 QUADRUPLE 2-INPUT POSITIVE-NAND GATE

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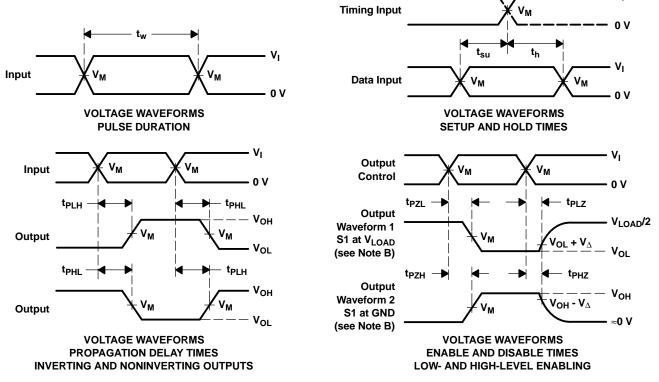
| TEST                               | S1                |
|------------------------------------|-------------------|
| t <sub>PLH</sub> /t <sub>PHL</sub> | Open              |
| t <sub>PLZ</sub> /t <sub>PZL</sub> | V <sub>LOAD</sub> |
| t <sub>PHZ</sub> /t <sub>PZH</sub> | GND               |

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LOAD CIRCUIT

| INPUTS                              |                 | PUTS                           | V                  | V                 | •     |              | v            |
|-------------------------------------|-----------------|--------------------------------|--------------------|-------------------|-------|--------------|--------------|
| V <sub>CC</sub>                     | VI              | t <sub>r</sub> /t <sub>f</sub> | V <sub>M</sub>     | V <sub>LOAD</sub> | CL    | RL           | $V_{\Delta}$ |
| $\fbox{1.8~V\pm0.15~V}$             | V <sub>CC</sub> | ≤2 ns                          | V <sub>CC</sub> /2 | $2 \times V_{CC}$ | 30 pF | <b>1 k</b> Ω | 0.15 V       |
| $\textbf{2.5 V} \pm \textbf{0.2 V}$ | V <sub>CC</sub> | ≤2 ns                          | V <sub>CC</sub> /2 | $2 \times V_{CC}$ | 30 pF | <b>500</b> Ω | 0.15 V       |
| 2.7 V                               | 2.7 V           | ≤2.5 ns                        | 1.5 V              | 6 V               | 50 pF | <b>500</b> Ω | 0.3 V        |
| 3.3 V $\pm$ 0.3 V                   | 2.7 V           | ≤2.5 ns                        | 1.5 V              | 6 V               | 50 pF | <b>500</b> Ω | 0.3 V        |



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
  C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z<sub>0</sub> = 50 Ω.
- D. The outputs are measured one at a time, with one transition per measurement.
- E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
- F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
- G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
- H. All parameters and waveforms are not applicable to all devices.

#### Figure 1. Load Circuit and Voltage Waveforms

27-Jan-2006

### **PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package<br>Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup>               |
|------------------|-----------------------|-----------------|--------------------|------|----------------|-------------------------|------------------|--|
| SN74LVC00AQDRQ1  | ACTIVE                | SOIC            | D                  | 14   | 2500           | Pb-Free<br>(RoHS)       | CU NIPDAU        | Level-2-250C-1 YEAR/<br>Level-1-235C-UNLIM |
| SN74LVC00AQPWRQ1 | ACTIVE                | TSSOP           | PW                 | 14   | 2000           | Pb-Free<br>(RoHS)       | CU NIPDAU        | Level-1-250C-UNLIM                         |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

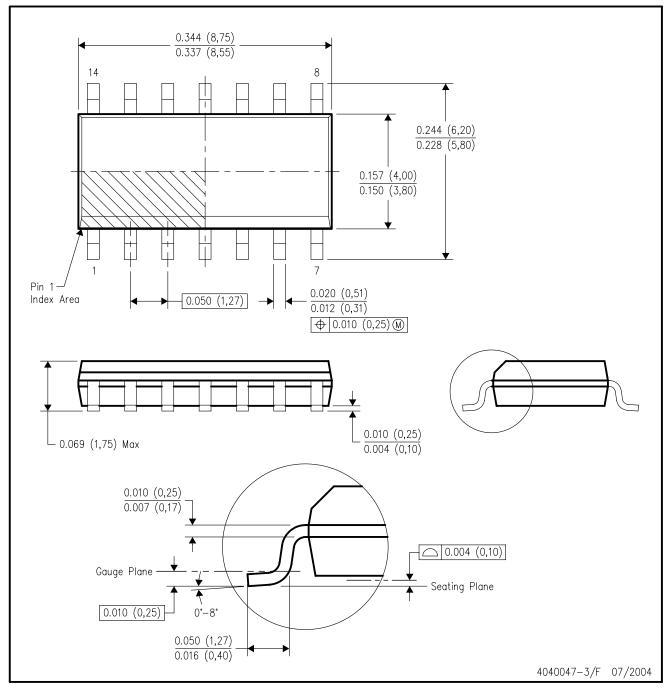
<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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D (R-PDSO-G14)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-012 variation AB.



# **MECHANICAL DATA**

MTSS001C - JANUARY 1995 - REVISED FEBRUARY 1999

#### PLASTIC SMALL-OUTLINE PACKAGE





NOTES: A. All linear dimensions are in millimeters.

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D. Falls within JEDEC MO-153



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